

KSC2310

High Voltage Power Amplifier

- Collector-Base Voltage: V_{CBO}=200V
 Current Gain Bandwidth Product: f_T=100MHz



1. Emitter 2. Collector 3. Base

NPN Epitaxial Silicon Transistor

Absolute Maximum Ratings Ta=25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{CBO}	Collector-Base Voltage	200	V
V _{CEO}	Collector-Emitter Voltage	150	V
V _{EBO}	Emitter-Base Voltage	5	V
Ic	Collector Current	50	mA
P _C	Collector Power Dissipation	800	mW
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55 ~ 150	°C

Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	I _C =10 <mark>0μΑ</mark> , I _E =0	200			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C=5mA$, $I_B=0$	150			V
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E =100μA, I _C =0	5			V
I _{CBO}	Collector Cut-off Current	V_{CB} =200V, I_{E} =0			0.1	μΑ
h _{FE}	DC Current Gain	V _{CE} =5V, I _C =10mA	40		240	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C =10mA, I _B =1mA			0.5	V
f _T	Current Gain Bandwidth Product	V_{CE} =30V, I_{C} =10mA		100		MHz
C _{ob}	Output Capacitance	V _{CB} =10V, I _E =0, f=1MHz		3.5	5	pF

h_{FF} Classification

Classification	R	0	Υ
h _{FE}	40 ~ 80	70 ~ 140	120 ~ 240

Typical Characteristics

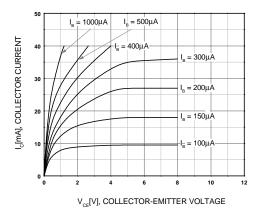


Figure 1. Static Characteristic

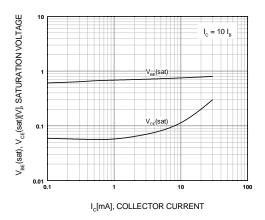


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

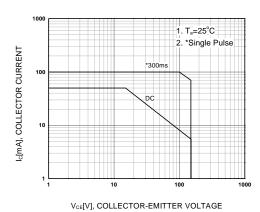
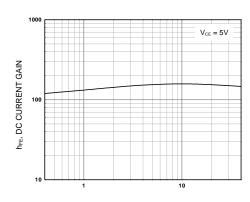
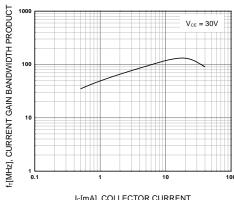


Figure 5. Safe Operating Area



I_C[mA], COLLECTOR CURRENT

Figure 2. DC current Gain



Ic[mA], COLLECTOR CURRENT

Figure 4. Current Gain Bandwidth Product

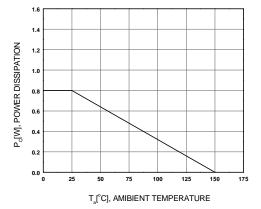
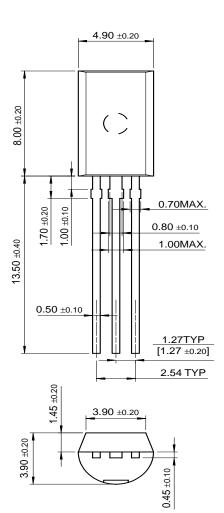


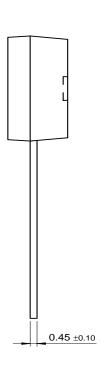
Figure 6. Power Derating

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Package Dimensions

TO-92L





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The Power Franc	hise™	OPTOLOGIC [®]	SILENT SWITCHER®	VCX^{TM}
Programmable Ad	ctive Droop™	OPTOPLANAR™	SMART START™	

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